

METHOD FOR FABRICATING A SEMICONDUCTOR DEVICE HAVING A HEAT SPREADING LAYER

Application No. [NEW] - Attorney Docket No. OKI.597

Inventors: Makoto TERUI et al.

Fig. 1

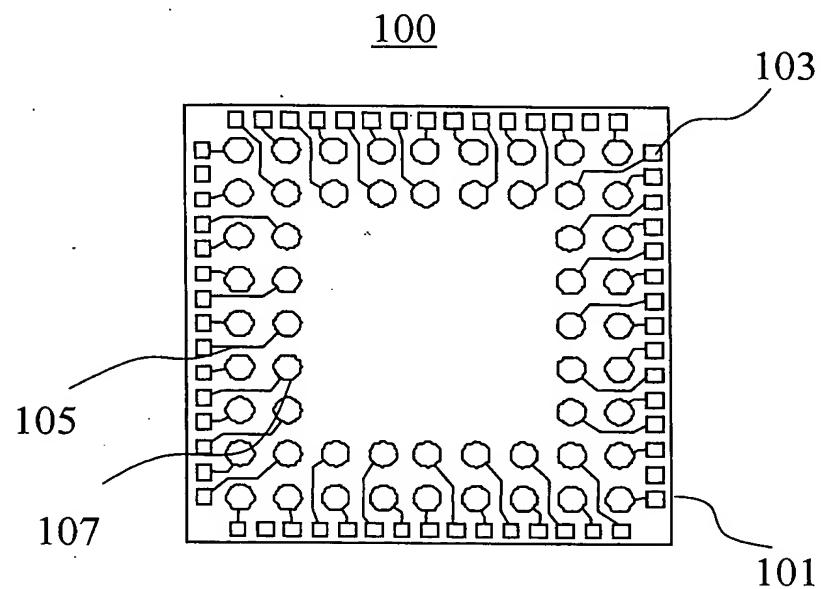
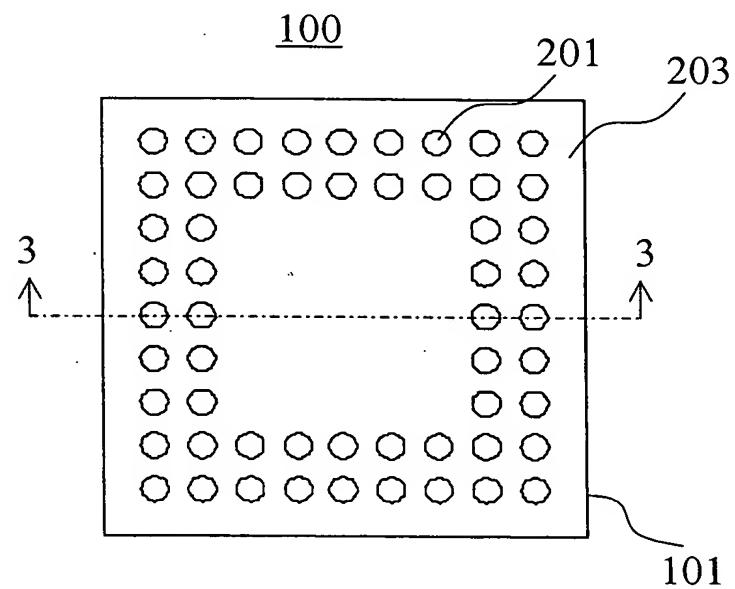


Fig. 2



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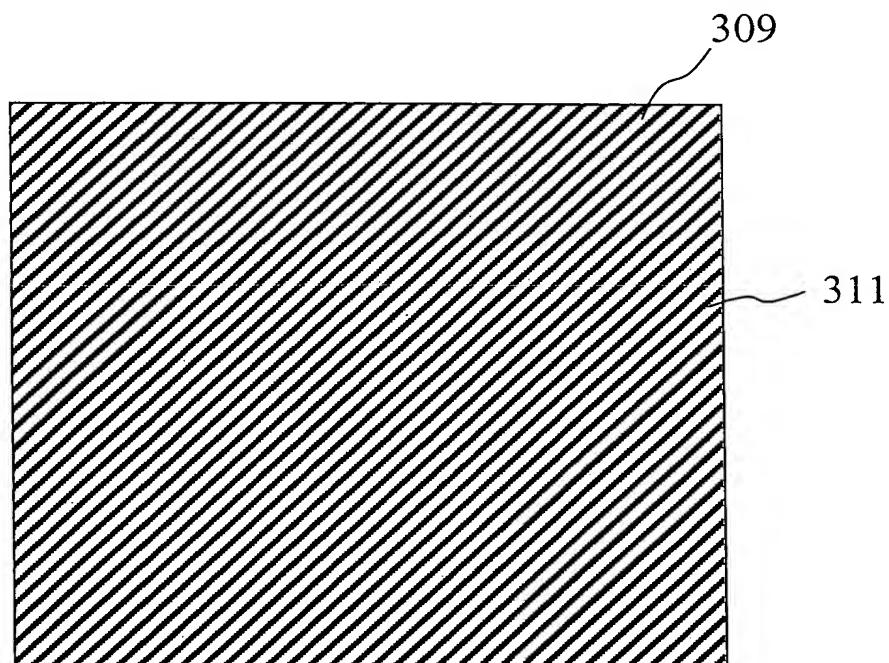
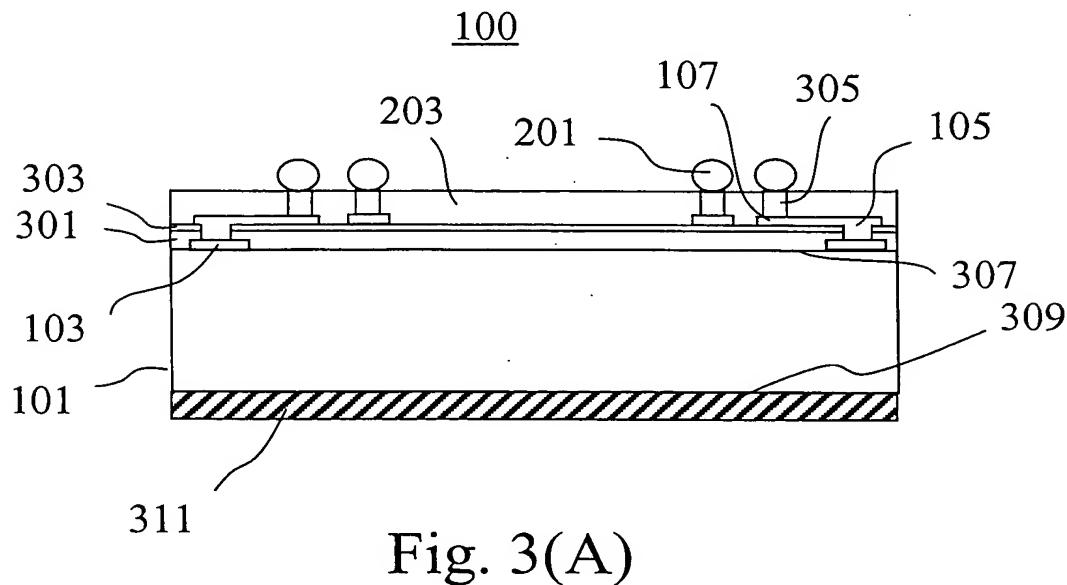


Fig. 3(B)

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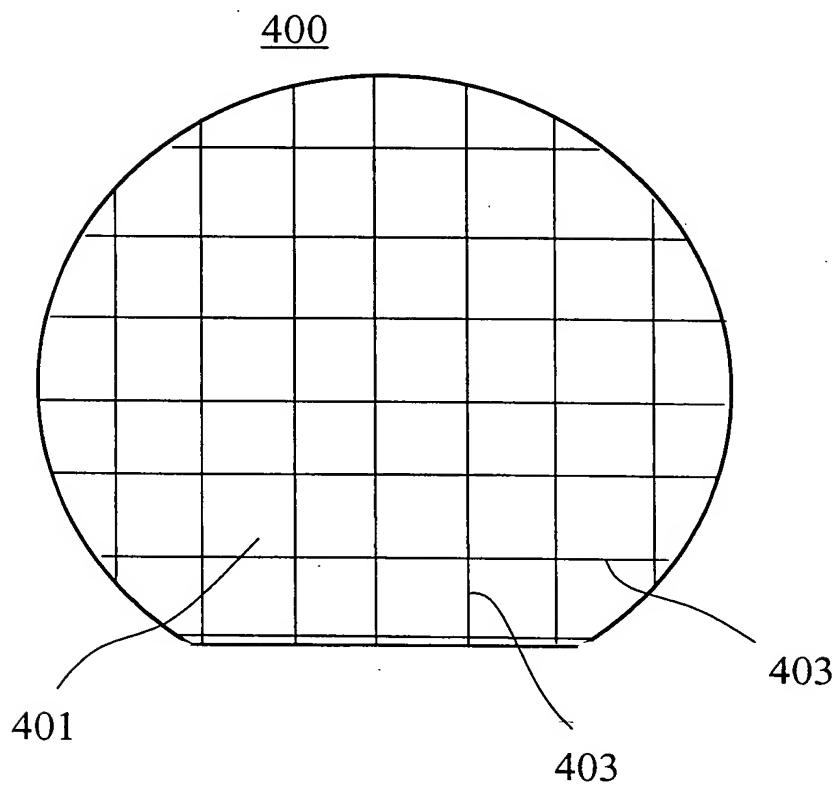
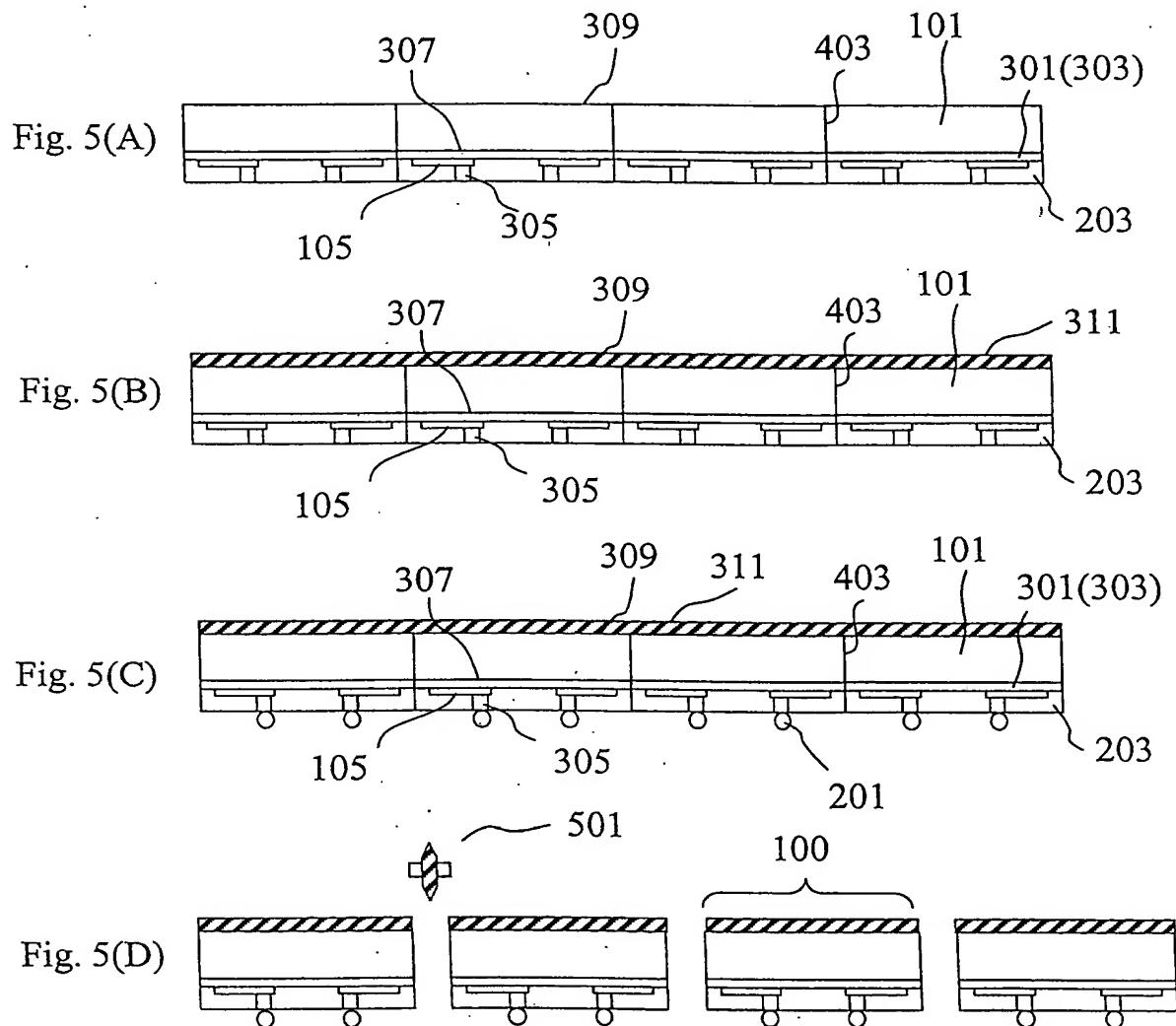
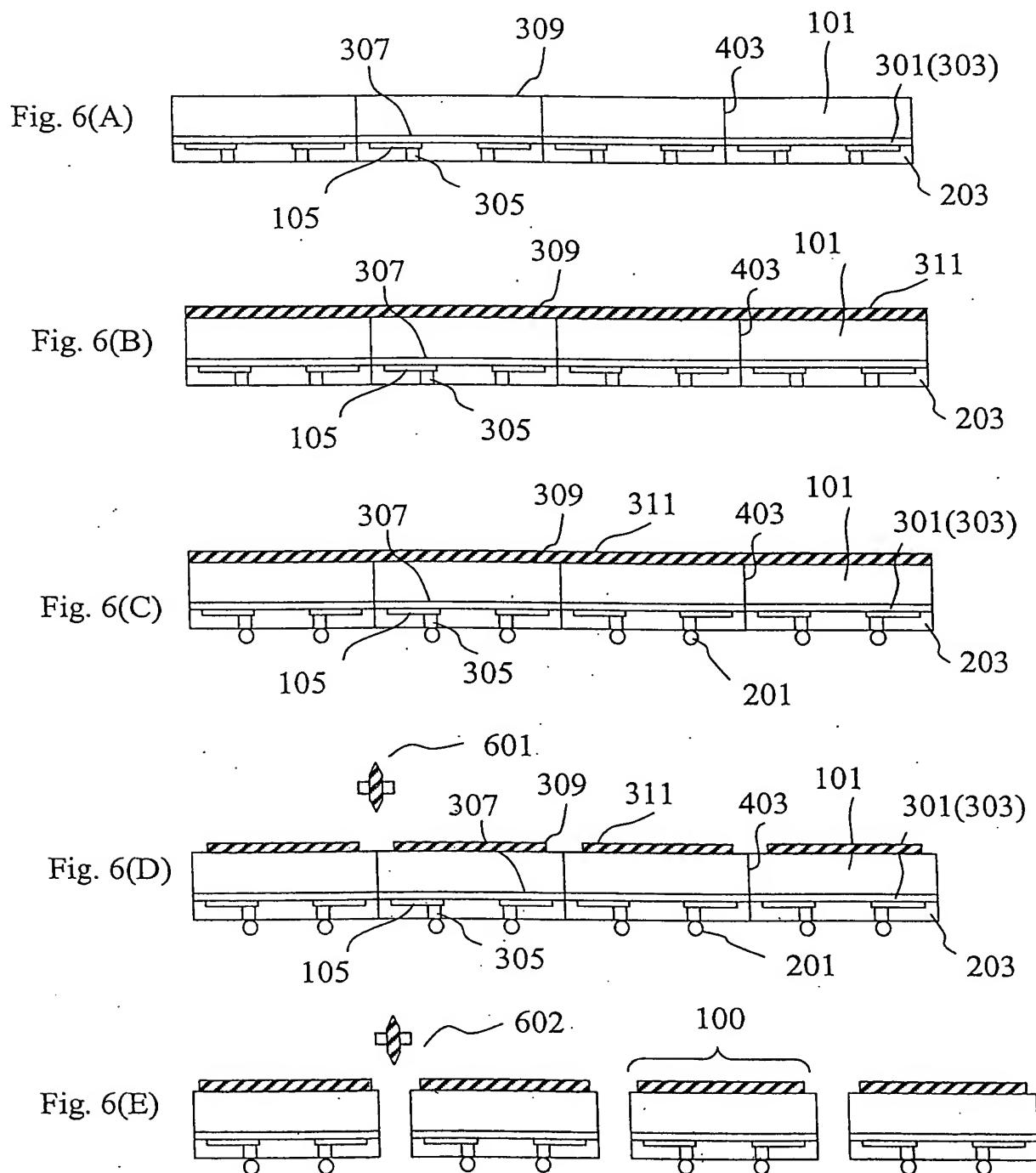


Fig. 4

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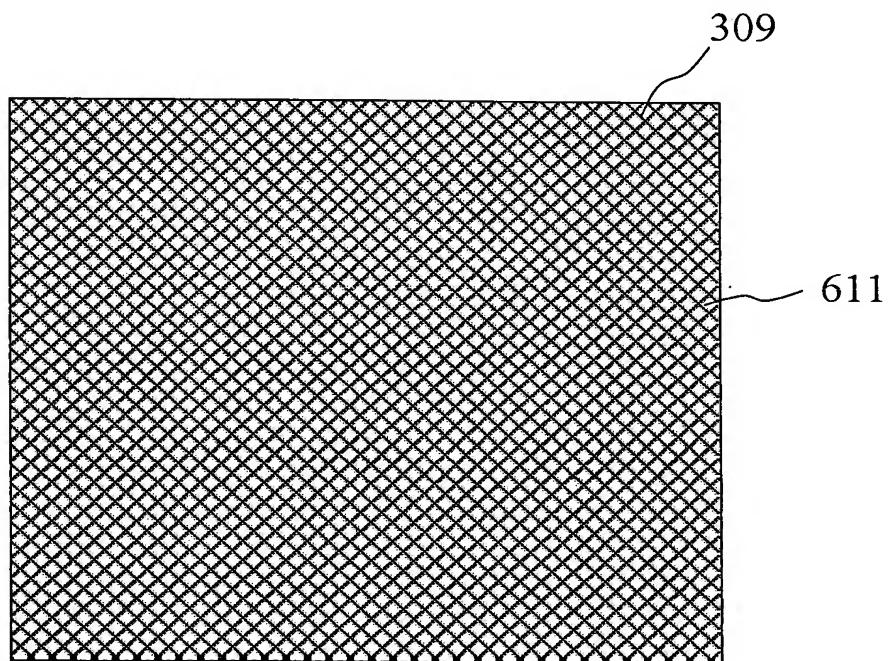
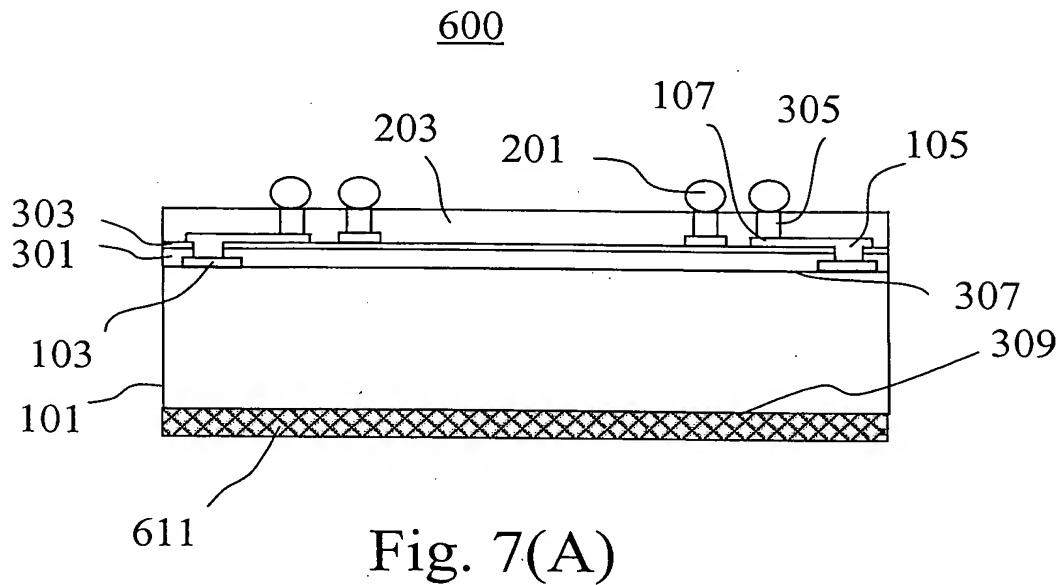
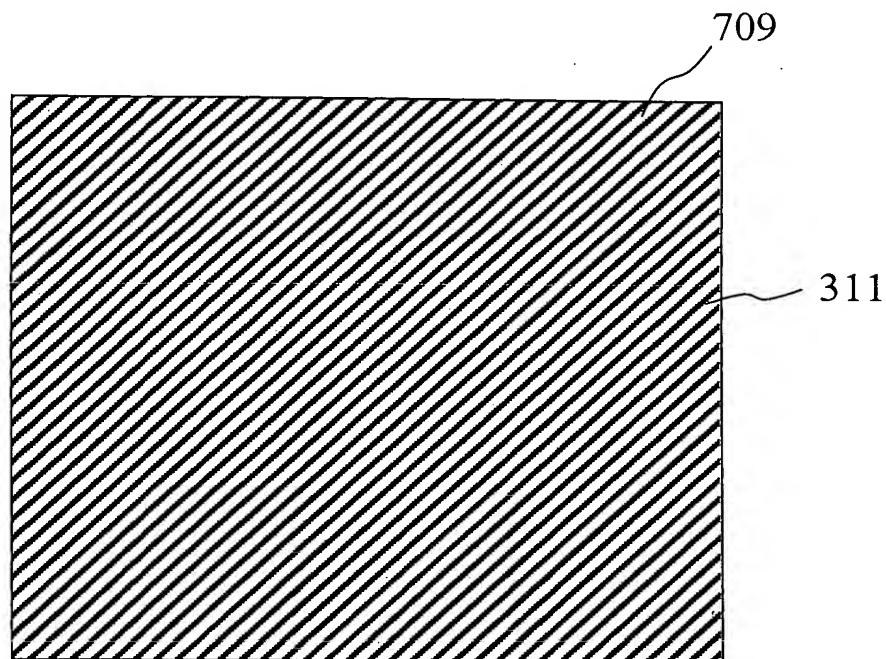
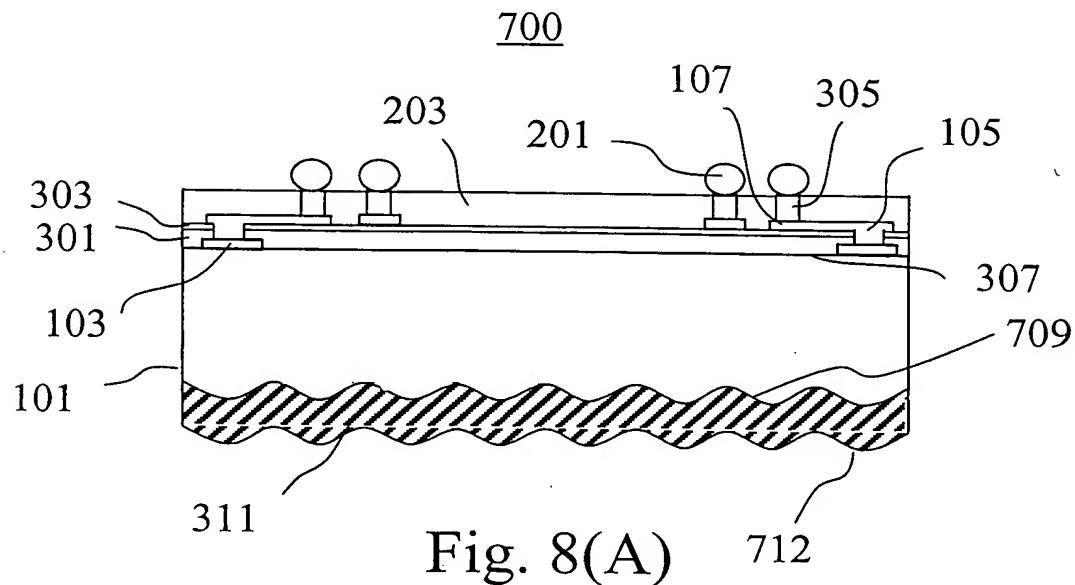


Fig. 7(B)

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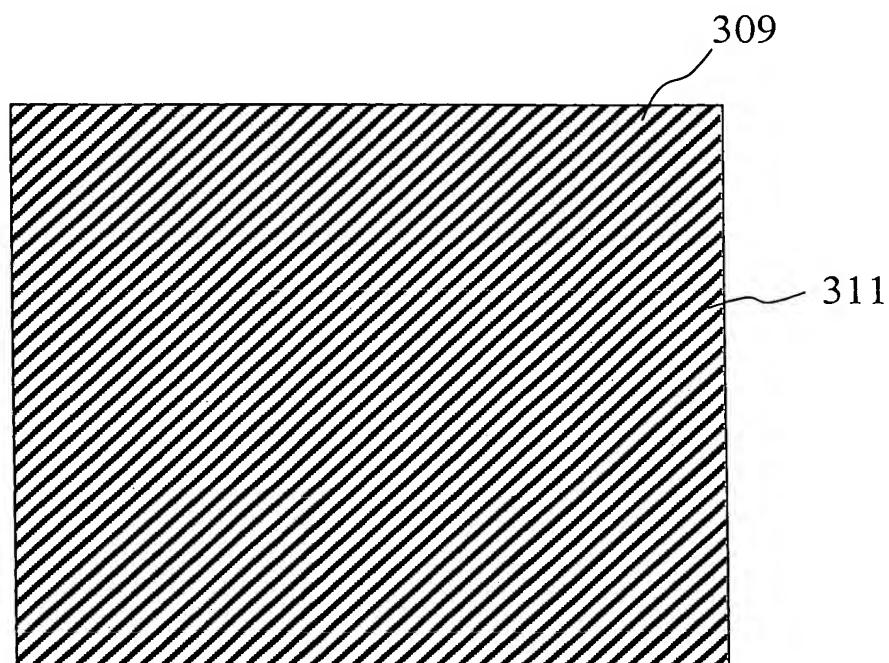
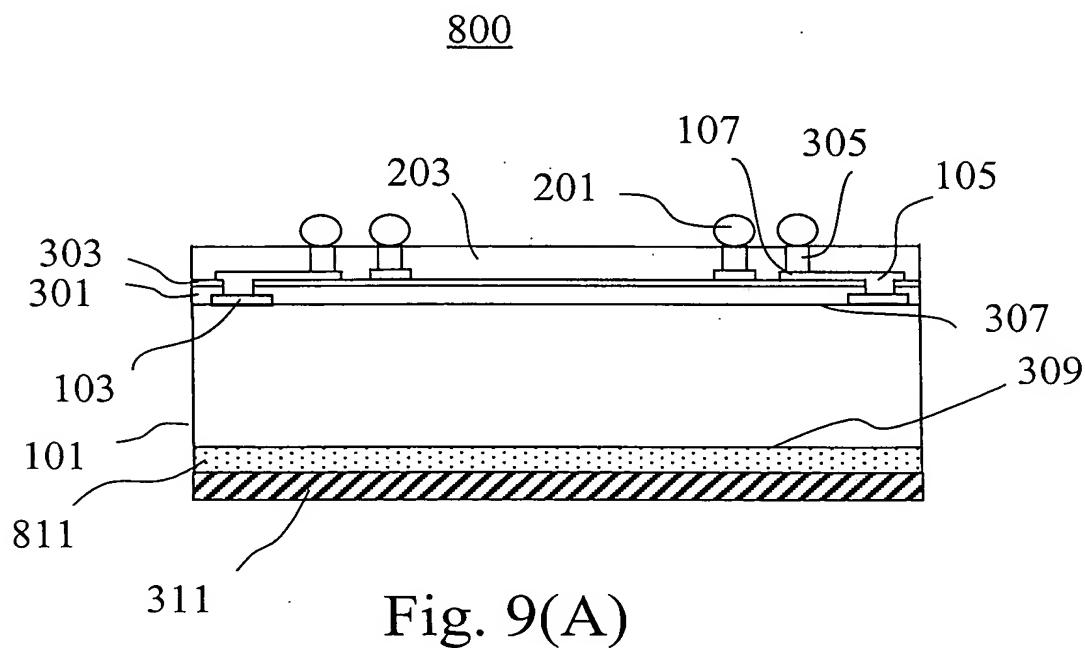


Fig. 9(B)

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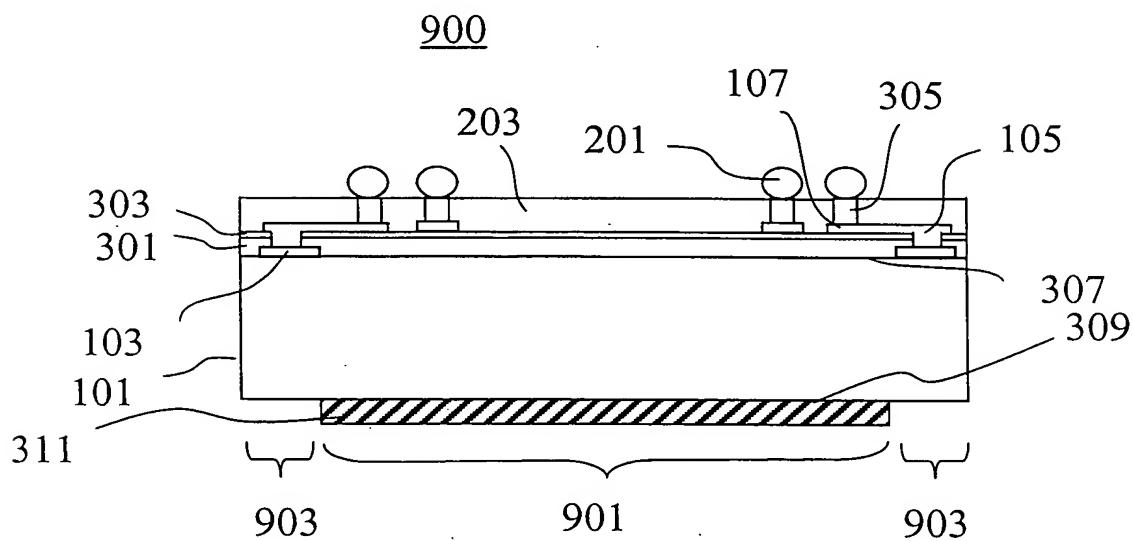


Fig. 10(A)

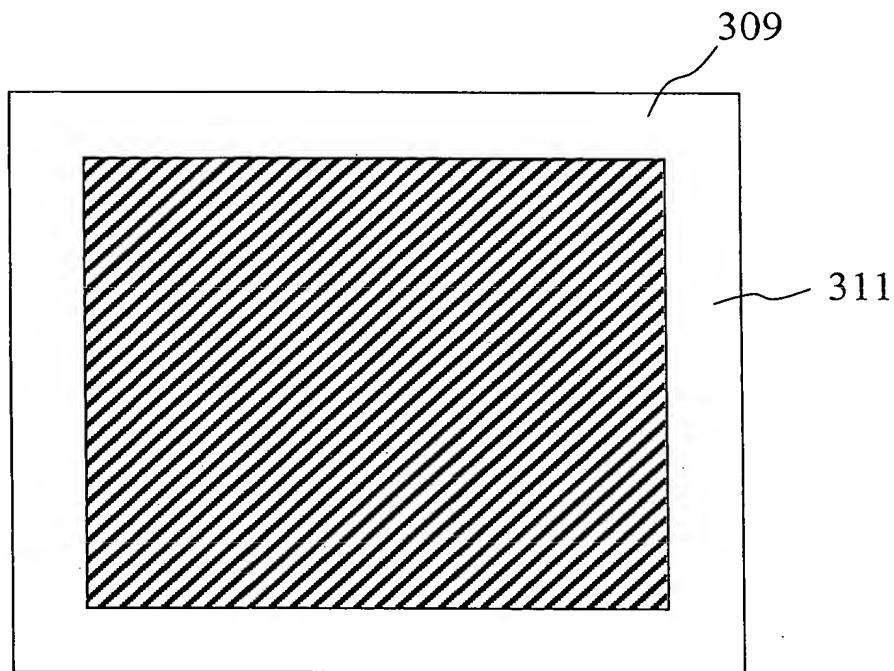
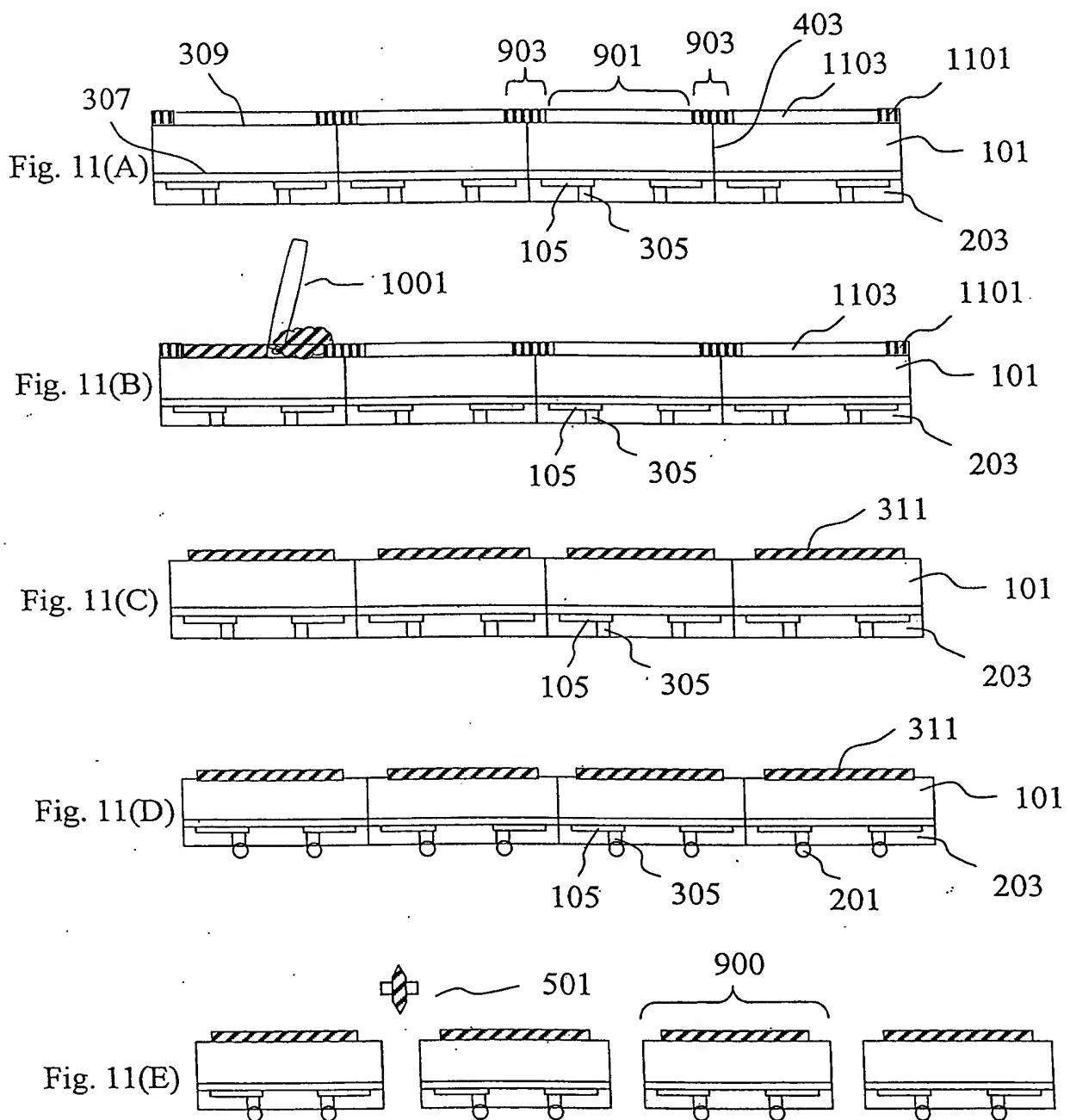


Fig. 10(B)

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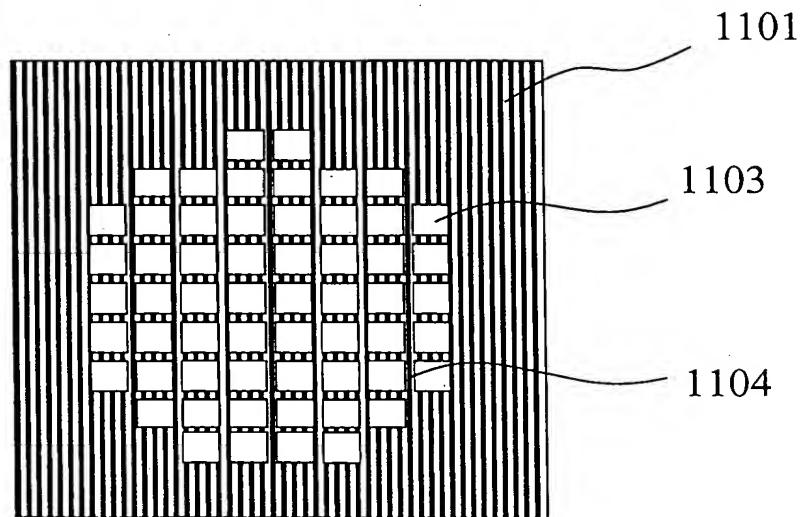


Fig. 12

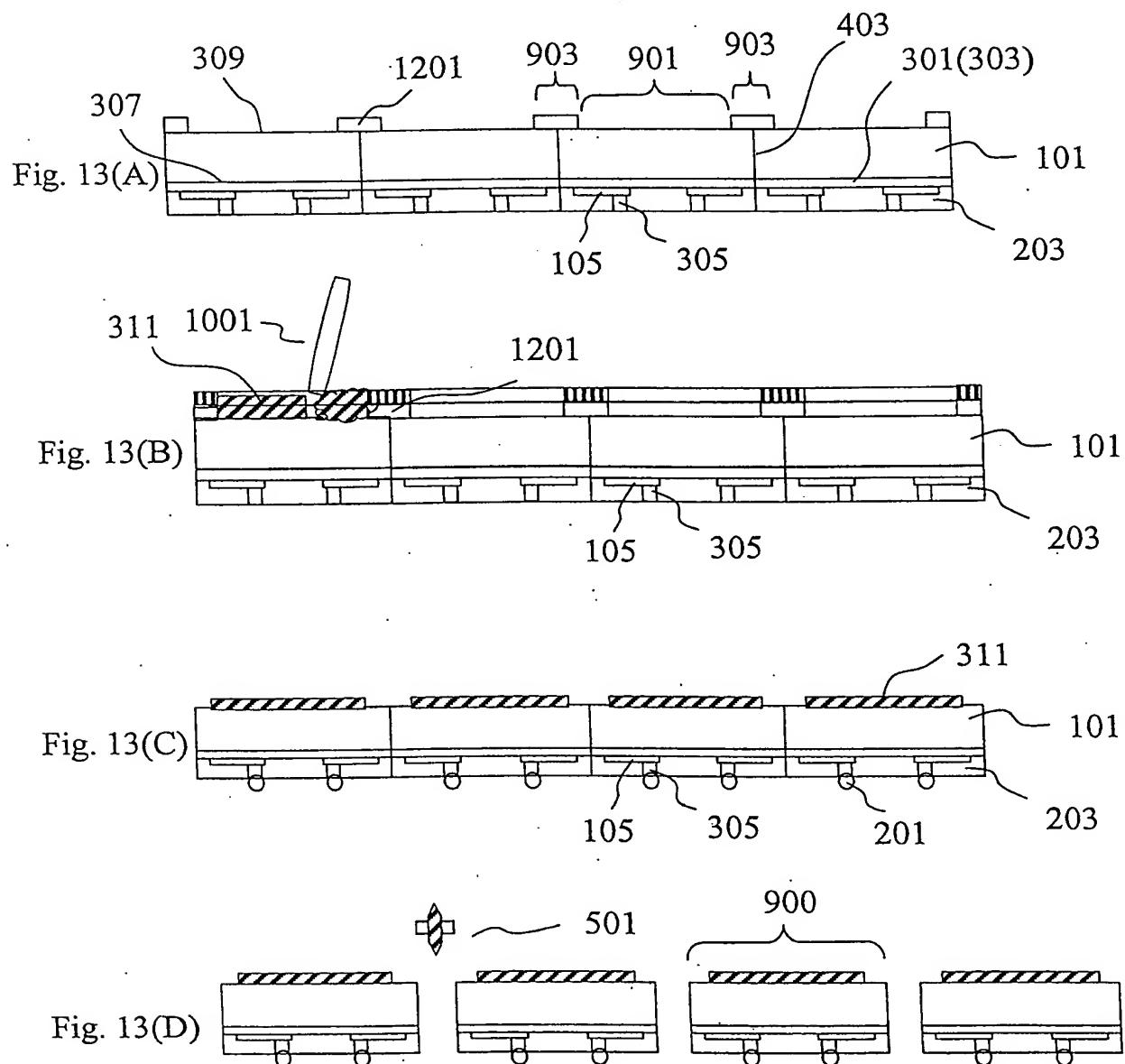
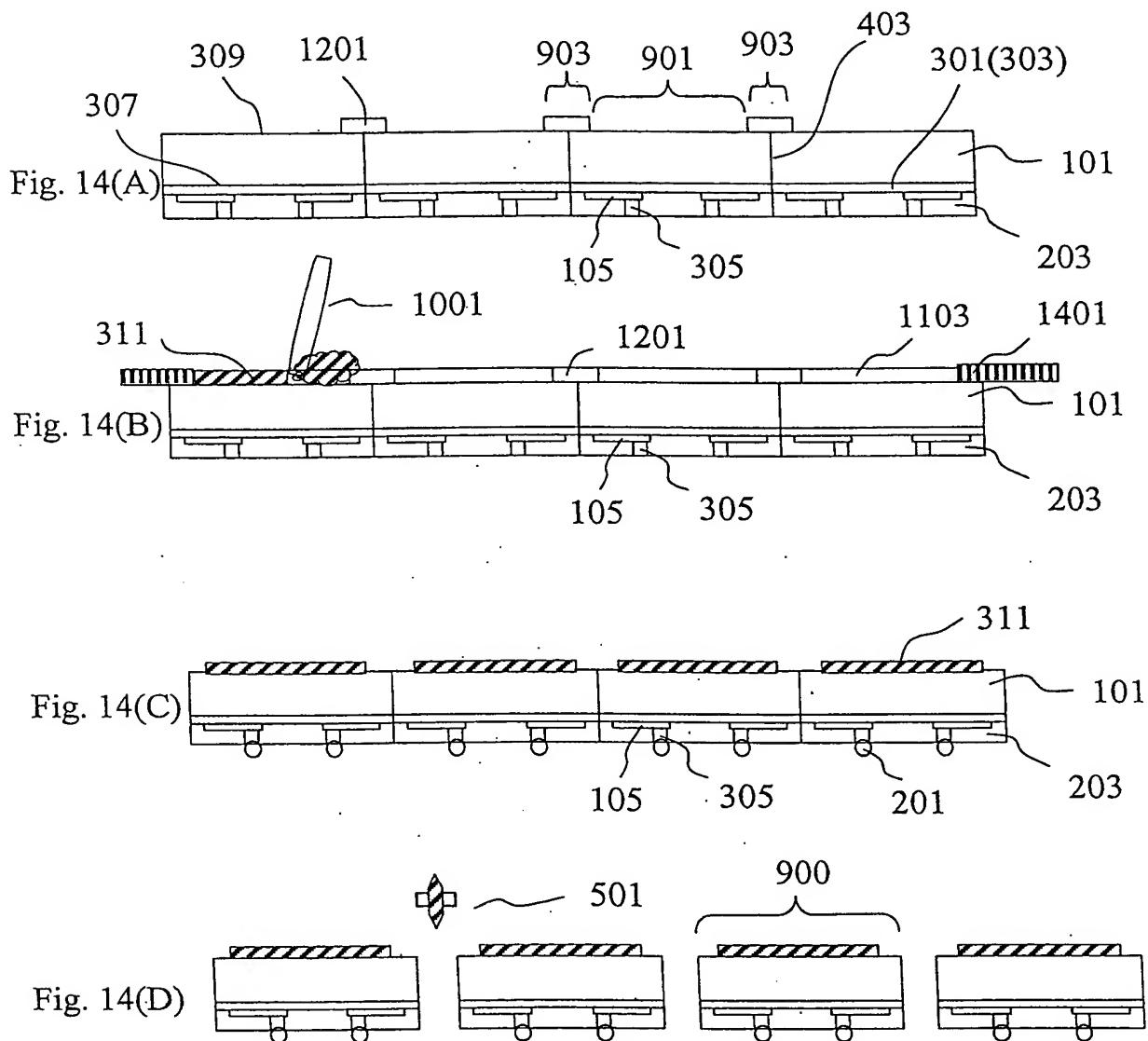


Fig. 13

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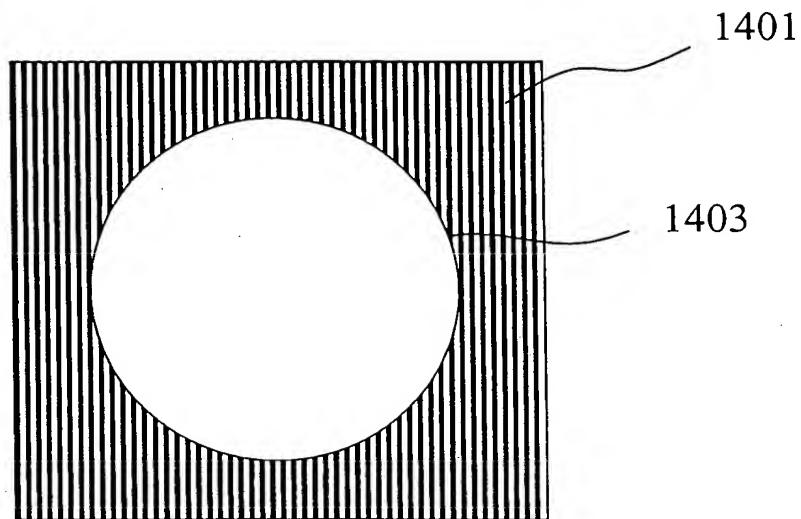
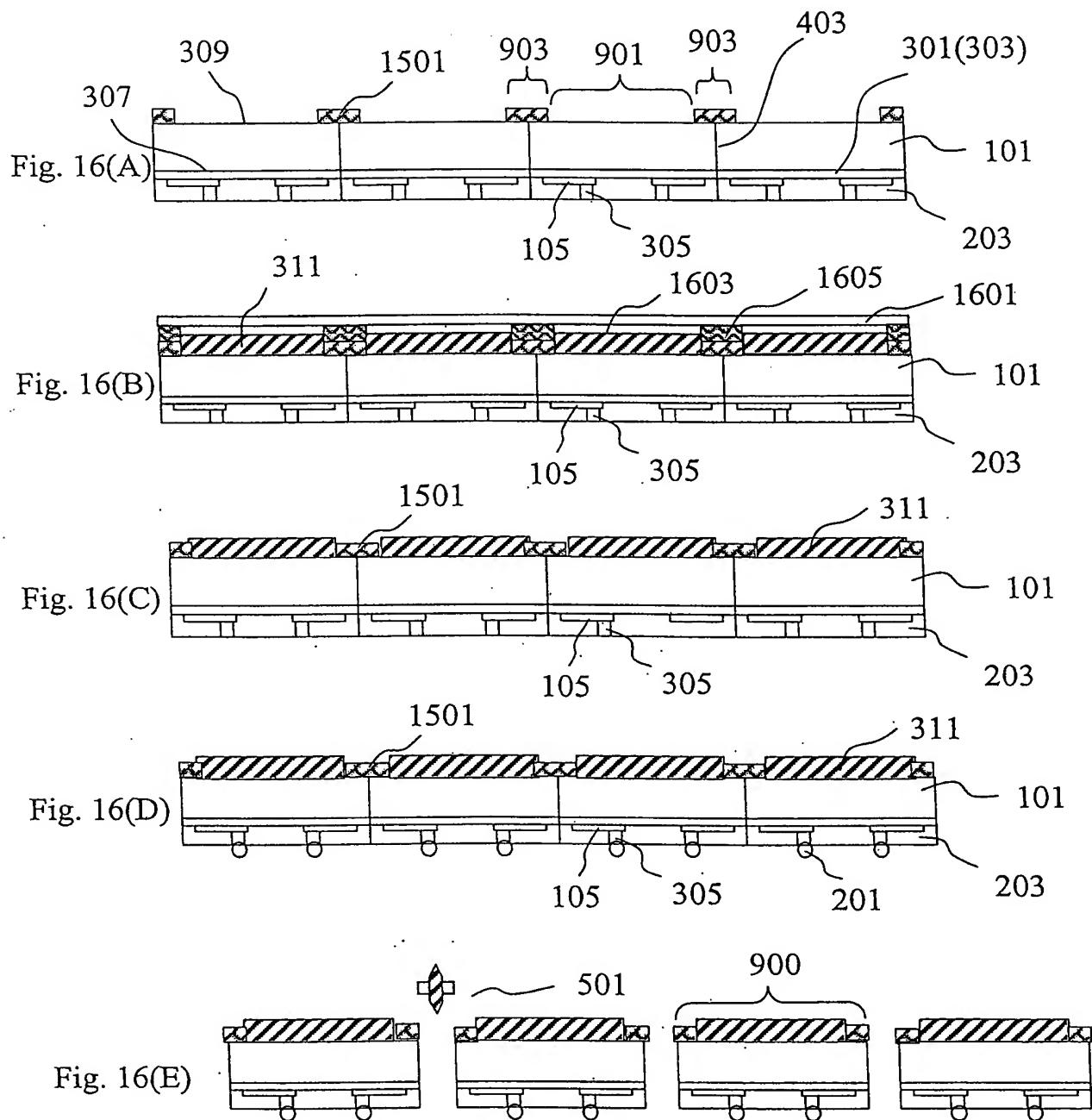


Fig. 15

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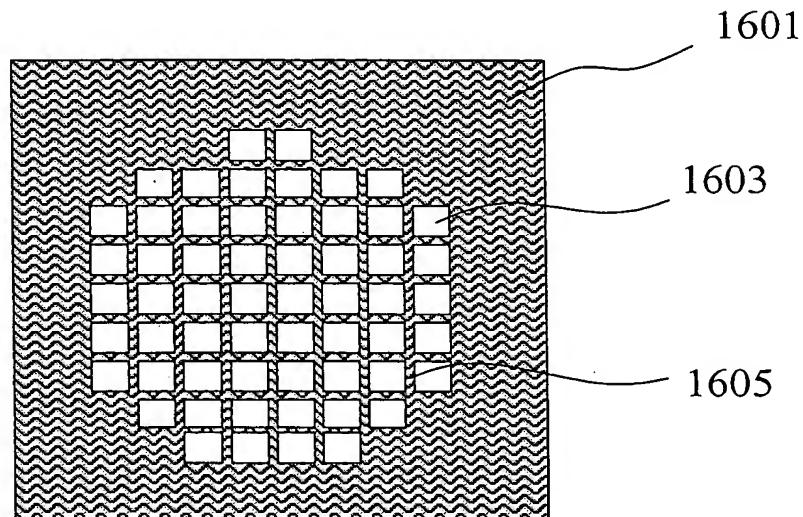
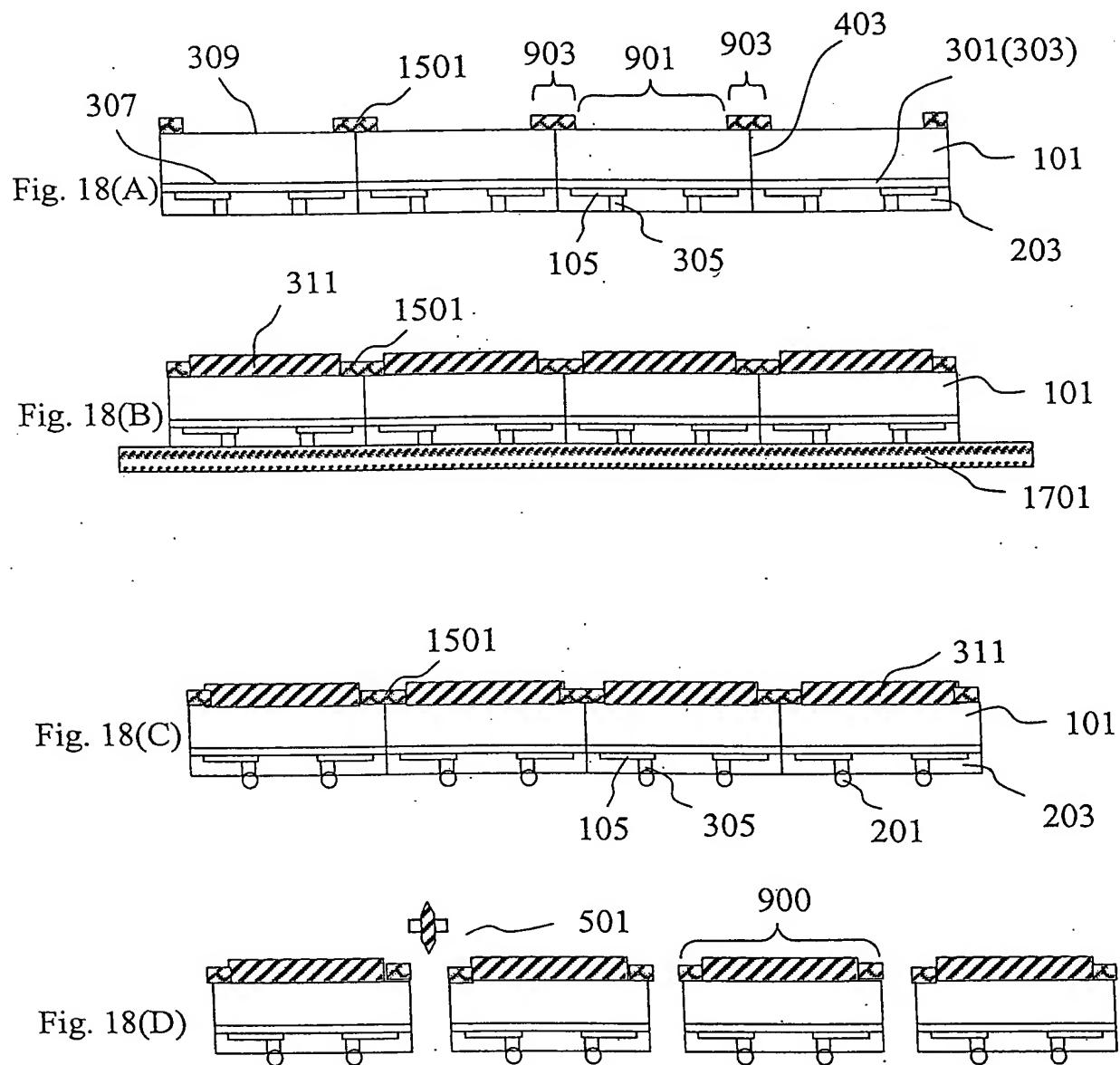


Fig. 17

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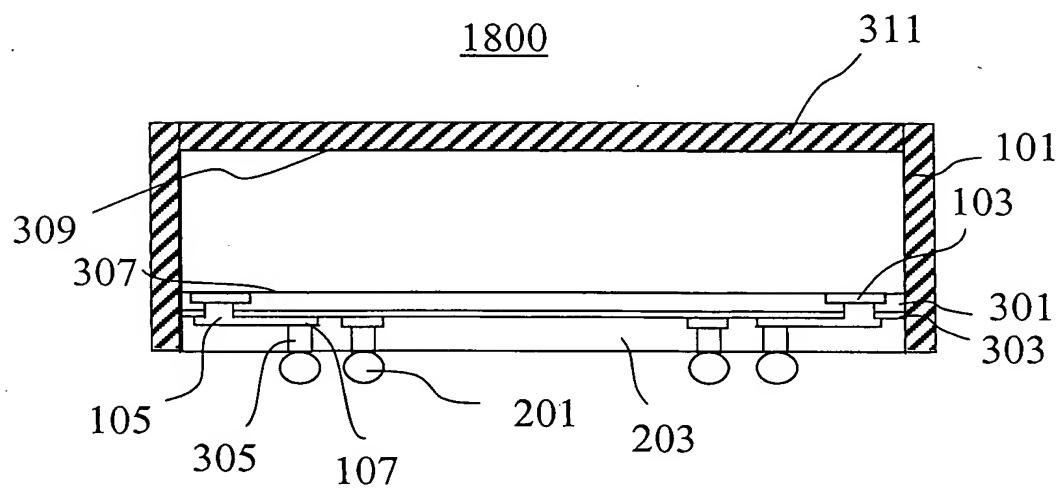


Fig. 19(A)

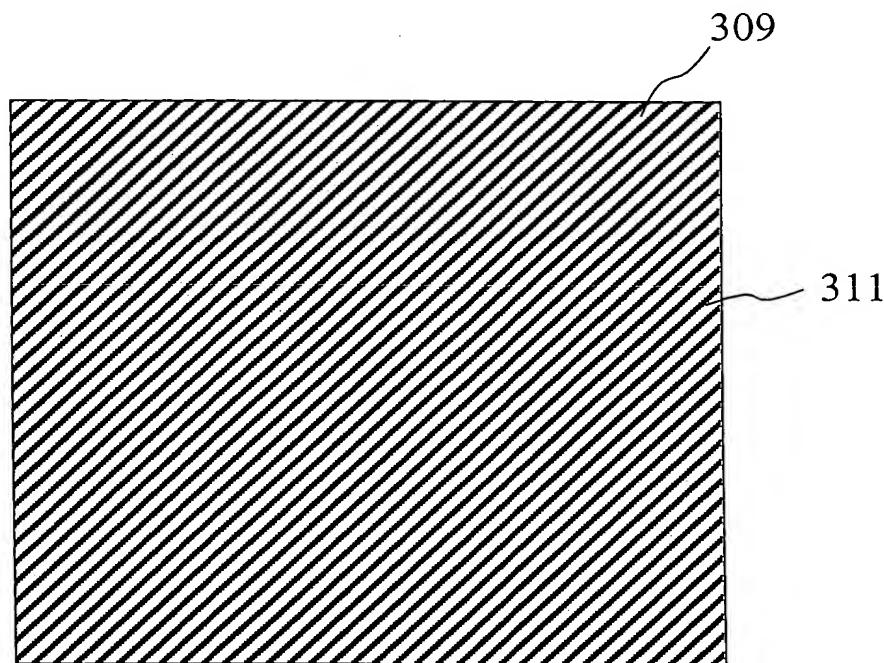


Fig. 19(B)

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